

Board Level Cooling – Surface Mount 5733



BOARD LEVEL COOLING – Surface Mount 5733

Surface Mount 5733 is a series of surface mount board level heat sinks designed to cool D2 Pak and TO-263 devices. Representative Image Only.

ORDERING INFORMATION

Part Number	Device Type
573300D00000G	D2 Pak, TO-263
573300D00010G	D2 Pak, TO-263



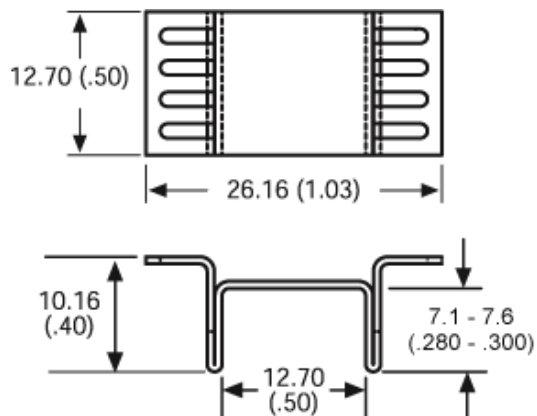
HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Tin Plated
Device Attachment Options	-
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	26.16
Heat Sink Length (mm)	12.70
Heat Sink Height (mm)	10.16
Heat Sink Mounting Direction	Horizontal

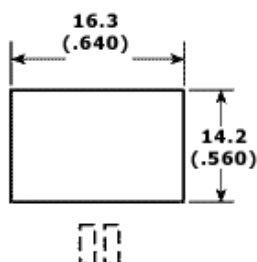
MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

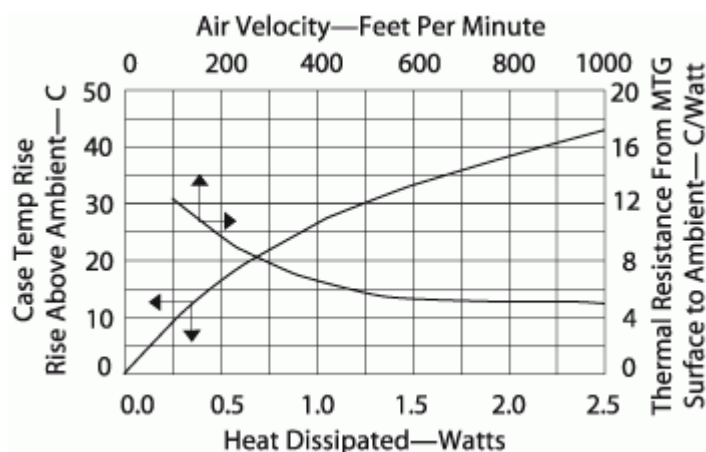
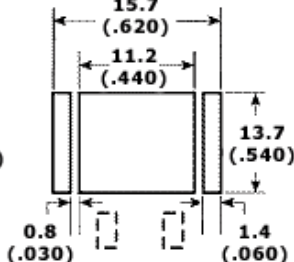


Note: The thickness of the drain pad is variable depending on the amount of heat generated by the SMT device, design, limitations and process. This is the exposed printed circuit.

Recommended Cu Heat Spreader Drain Pad



Recommended Heat Sink Solder Mask Opening



Mouser Electronics

Authorized Distributor

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[573300D00010G](#) [573300D00000G](#)